

### 10mm (0.4INCH) DUAL DIGIT NUMERIC DISPLAY

Part Number: DC04-11SURKWA Hyper Red

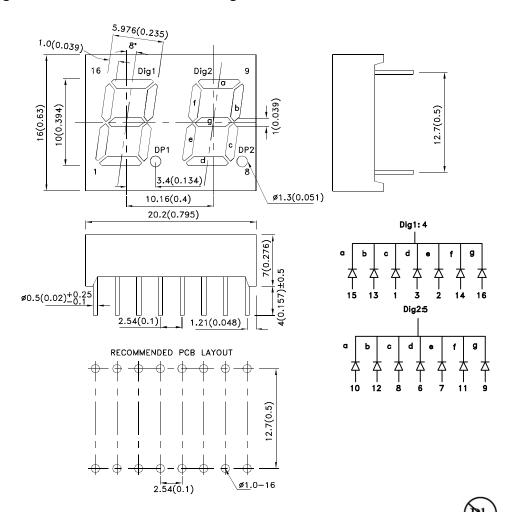
#### **Features**

- 0.4 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Two digit package simplifies alignments & assembly.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

#### Description

The Hyper Red source color devices are made with Al-GalnP on GaAs substrate Light Emitting Diode.

#### Package Dimensions& Internal Circuit Diagram



#### Notes:

1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.

2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 SPEC NO: DSAM8351
 REV NO: V.1A
 DATE: JAN/19/2013
 PAGE: 1 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: Y.Liu
 ERP: 1302001062

#### **Selection Guide**

Part No.	Dice	Lens Type	lv (uc @ 10		Description
		3,1	Min.	Тур.	
DC04-11SURKWA	Hyper Red (AlGaInP)	White Diffused	21000	54000	Common Cathode
			*9000	*18000	

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	645		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
lR	Reverse Current	Hyper Red		10	uA	V <sub>R</sub> =5V

- 1.Wavelength: +/-1nm.
  2. Forward Voltage: +/-0.1V.
  3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

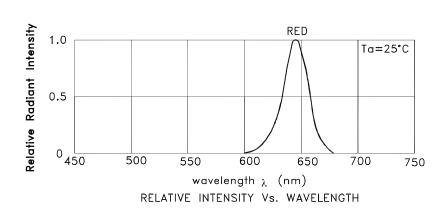
### Absolute Maximum Ratings at TA=25°C

<u> </u>			
Hyper Red			
75	mW		
30	mA		
185	mA		
5	V		
-40°C To +85°C	•		
.ead Solder Temperature[2] 260°C For 3-5 Seconds			
	Hyper Red  75  30  185  5  -40°C To +85°C		

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. 2mm below package base.

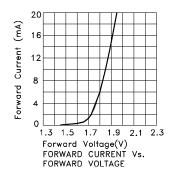
SPEC NO: DSAM8351 **REV NO: V.1A** DATE: JAN/19/2013 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED:** Joe Lee DRAWN: Y.Liu ERP: 1302001062

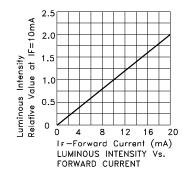
Luminous intensity/ luminous Flux: +/-15%.
 \*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

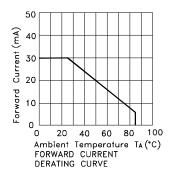


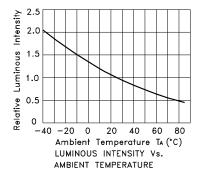
### **Hyper Red**

#### DC04-11SURKWA

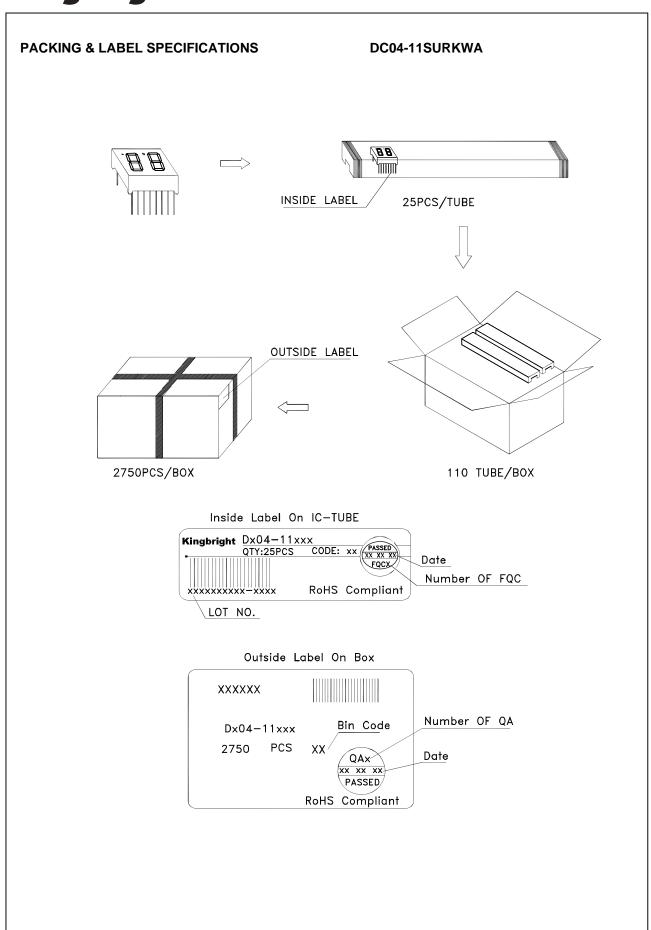








SPEC NO: DSAM8351 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JAN/19/2013 DRAWN: Y.Liu PAGE: 3 OF 6 ERP: 1302001062



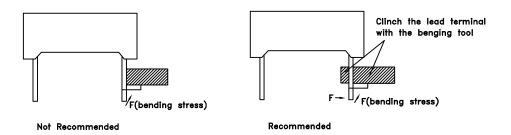
SPEC NO: DSAM8351 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JAN/19/2013 DRAWN: Y.Liu

PAGE: 4 OF 6 ERP: 1302001062

#### THROUGH HOLE DISPLAY MOUNTING METHOD

### Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

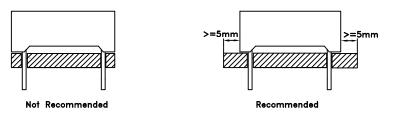


#### Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



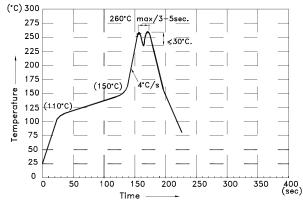
3. The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



SPEC NO: DSAM8351 APPROVED: WYNEC REV NO: V.1A CHECKED: Joe Lee DATE: JAN/19/2013 DRAWN: Y.Liu PAGE: 5 OF 6 ERP: 1302001062

#### DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



#### NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top—surface temperature should be kept below 105°C 5.No more than once.

#### Soldering General Notes:

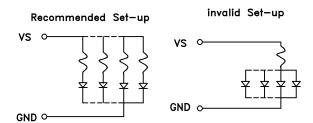
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

#### **CLEANING**

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

#### CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



All design applications should refer to Kingbright application notes available at <a href="http://www.KingbrightUSA.com/ApplicationNotes">http://www.KingbrightUSA.com/ApplicationNotes</a>

SPEC NO: DSAM8351 REV NO: V.1A DATE: JAN/19/2013 PAGE: 6 OF 6

APPROVED: WYNEC CHECKED: Joe Lee DRAWN: Y.Liu ERP: 1302001062